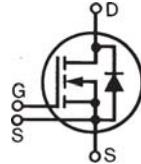


# HiPerFET™ Power MOSFET

## Single MOSFET Die

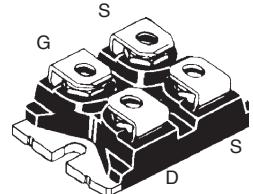
|                                | <b>V<sub>DSS</sub></b> | <b>I<sub>D25</sub></b> | <b>R<sub>DS(on)</sub></b> |
|--------------------------------|------------------------|------------------------|---------------------------|
| <b>IXFN 24N100</b>             | <b>1000 V</b>          | <b>24 A</b>            | <b>0.39 Ω</b>             |
| <b>IXFN 23N100</b>             | <b>1000 V</b>          | <b>23 A</b>            | <b>0.43 Ω</b>             |
| <b>t<sub>rr</sub> ≤ 250 ns</b> |                        |                        |                           |



## Symbol Test Conditions

|               |   |                                    |      |   |
|---------------|---|------------------------------------|------|---|
| $V_{DSS}$     | $T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$   | 1000                               | V    |   |
| $V_{DGR}$     | $T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$ , $R_{GS} = 1\text{ M}\Omega$   | 1000                               | V    |   |
| $V_{GS}$      | Continuous  | $\pm 20$                           | V    |   |
| $V_{GSM}$     | Transient   | $\pm 30$                           | V    |   |
| $I_{D25}$     | $T_C = 25^\circ\text{C}$  | 24N100                             | 24   | A |
|               |   | 23N100                             | 23   | A |
| $I_{DM}$      | $T_C = 25^\circ\text{C}$ ; Note 1   | 24N100                             | 96   | A |
|               |   | 23N100                             | 92   | A |
| $I_{AR}$      | $T_C = 25^\circ\text{C}$  | 24                                 | A    |   |
| $E_{AR}$      | $T_C = 25^\circ\text{C}$  | 60                                 | mJ   |   |
| $E_{AS}$      | $T_C = 25^\circ\text{C}$  | 3                                  | J    |   |
| $dv/dt$       | $I_S \leq I_{DM}$ , $di/dt \leq 100 \text{ A}/\mu\text{s}$ , $V_{DD} \leq V_{DSS}$<br>$T_J \leq 150^\circ\text{C}$ , $R_G = 2 \Omega$ | 5                                  | V/ns |   |
| $P_D$         | $T_C = 25^\circ\text{C}$  | 600                                | W    |   |
| $T_J$         |   | -55 ... +150                       | °C   |   |
| $T_{JM}$      |   | 150                                | °C   |   |
| $T_{stg}$     |   | -55 ... +150                       | °C   |   |
| $T_L$         | 1.6 mm (0.063 in) from case for 10 s  | 300                                | °C   |   |
| $V_{ISOL}$    | 50/60 Hz, RMS $t = 1 \text{ min}$<br>$I_{ISOL} \leq 1 \text{ mA}$ $t = 1 \text{ s}$   | 2500<br>3000                       | V~   |   |
| $M_d$         | Mounting torque<br>Terminal connection torque   | 1.5/13 Nm/lb.in<br>1.5/13 Nm/lb.in |      |   |
| <b>Weight</b> |   | 30                                 | g    |   |

miniBLOC, SOT-227 B (IXFN)



G = Gate  
S = Source

D = Drain

Either Source terminal at miniBLOC can be used as Main or Kelvin Source

## Features

- International standard package
  - Encapsulating epoxy meets UL 94 V-0, flammability classification
  - miniBLOC with Aluminium nitride isolation
  - Low  $R_{DS\ (on)}$  HDMOS™ process
  - Rugged polysilicon gate cell structure
  - Unclamped Inductive Switching (UIS) rated
  - Low package inductance
  - Fast intrinsic Rectifier

## Applications

- DC-DC converters
  - Synchronous rectification
  - Battery chargers
  - Switched-mode and resonant-mode power supplies
  - DC choppers
  - Temperature and lighting controls
  - Low voltage relays

## **Advantages**

- Easy to mount
  - Space savings
  - High power density

| Symbol  | Test Conditions  | Characteristic Values                           |      |                  |
|---|--|---|------|------------------|
| (T <sub>j</sub> = 25°C, unless otherwise specified) |  | Min.  | Typ. | Max.             |
| V <sub>DSS</sub>                                    | V <sub>GS</sub> = 0 V, I <sub>D</sub> = 3mA                              | 1000  |      | V                |
| V <sub>GS(th)</sub>                                 | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 8mA                 | 3.0   |      | 5.5 V            |
| I <sub>GSS</sub>                                    | V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V                             |   |      | ±100 nA          |
| I <sub>DSS</sub>                                    | V <sub>DS</sub> = V <sub>DSS</sub><br>V <sub>GS</sub> = 0 V              | T <sub>j</sub> = 25°C<br>T <sub>j</sub> = 125°C |      | 100 μA<br>2 mA   |
| R <sub>DS(on)</sub>                                 | V <sub>GS</sub> = 10V, I <sub>D</sub> = 0.5 i I <sub>D25</sub><br>Note 2 | 23N100<br>24N100                                |      | 0.43 Ω<br>0.39 Ω |

| Symbol       | Test Conditions   | Characteristic Values |      |      |
|--------------|---|-----------------------|------|------|
|              | ( $T_j = 25^\circ\text{C}$ , unless otherwise specified)  | Min.                  | Typ. | Max. |
| $g_{fs}$     | $V_{DS} = 10 \text{ V}; I_D = 0.5 \text{ mA}$ , Note 2  | 15                    | 22   | S    |
| $C_{iss}$    |   | 7000                  |      | pF   |
| $C_{oss}$    | $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$  | 750                   |      | pF   |
| $C_{rss}$    |   | 260                   |      | pF   |
| $t_{d(on)}$  | $V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \text{ V}_{DSS}, I_D = 0.5 \text{ mA}$ ,<br>$R_G = 1 \Omega$ (External), | 35                    |      | ns   |
| $t_r$        |   | 35                    |      | ns   |
| $t_{d(off)}$ |   | 75                    |      | ns   |
| $t_f$        |   | 21                    |      | ns   |
| $Q_{g(on)}$  | $V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \text{ V}_{DSS}, I_D = 0.5 \text{ mA}$                                   | 250                   |      | nC   |
| $Q_{gs}$     |   | 55                    |      | nC   |
| $Q_{gd}$     |   | 135                   |      | nC   |
| $R_{thJC}$   |   |                       | 0.21 | K/W  |
| $R_{thCK}$   |   |                       | 0.05 | K/W  |

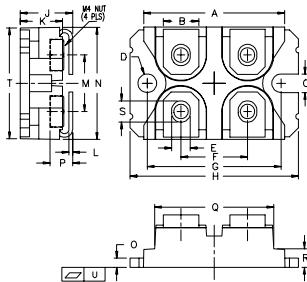
### Source-Drain Diode

( $T_j = 25^\circ\text{C}$ , unless otherwise specified)  
**Symbol**    **Test Conditions**

| Symbol                           | Test Conditions  | Characteristic Values |          |                          |
|----------------------------------|--|-----------------------|----------|--------------------------|
|                                  |  | Min.                  | Typ.     | Max.                     |
| $I_s$                            | $V_{GS} = 0$   | 24N100                | 24       | A                        |
|                                  |  | 23N100                | 23       | A                        |
| $I_{SM}$                         | Repetitive;<br>pulse width limited by $T_{JM}$   | 24N100                | 96       | A                        |
|                                  |  | 23N100                | 92       | A                        |
| $V_{SD}$                         | $I_F = I_s, V_{GS} = 0 \text{ V}$ ,<br>Pulse test, $t \leq 300 \mu\text{s}$ , duty cycle $d \leq 2 \%$ |                       | 1.5      | V                        |
| $t_{rr}$<br>$Q_{RM}$<br>$I_{RM}$ | $I_F = I_s, -di/dt = 100 \text{ A}/\mu\text{s}, V_R = 100 \text{ V}$                                   | 1.0                   | 250<br>8 | ns<br>$\mu\text{C}$<br>A |

Notes: 1. Pulse width limited by  $T_{JM}$ .  
 2. Pulse test,  $t \leq 300 \text{ ms}$ , duty cycle  $d \leq 2 \%$ .

### miniBLOC, SOT-227 B



M4 screws (4x) supplied

| Dim. | Millimeter |       | Inches |       |
|------|------------|-------|--------|-------|
|      | Min.       | Max.  | Min.   | Max.  |
| A    | 31.50      | 31.88 | 1.240  | 1.255 |
| B    | 7.80       | 8.20  | 0.307  | 0.323 |
| C    | 4.09       | 4.29  | 0.161  | 0.169 |
| D    | 4.09       | 4.29  | 0.161  | 0.169 |
| E    | 4.09       | 4.29  | 0.161  | 0.169 |
| F    | 14.91      | 15.11 | 0.587  | 0.595 |
| G    | 30.12      | 30.30 | 1.186  | 1.193 |
| H    | 38.00      | 38.23 | 1.496  | 1.505 |
| J    | 11.68      | 12.22 | 0.460  | 0.481 |
| K    | 8.92       | 9.60  | 0.351  | 0.378 |
| L    | 0.76       | 0.84  | 0.030  | 0.033 |
| M    | 12.60      | 12.85 | 0.496  | 0.506 |
| N    | 25.15      | 25.42 | 0.990  | 1.001 |
| O    | 1.98       | 2.13  | 0.078  | 0.084 |
| P    | 4.95       | 5.97  | 0.195  | 0.235 |
| Q    | 26.54      | 26.90 | 1.045  | 1.059 |
| R    | 3.94       | 4.42  | 0.155  | 0.174 |
| S    | 4.72       | 4.85  | 0.186  | 0.191 |
| T    | 24.59      | 25.07 | 0.968  | 0.987 |
| U    | -0.05      | 0.1   | -0.002 | 0.004 |

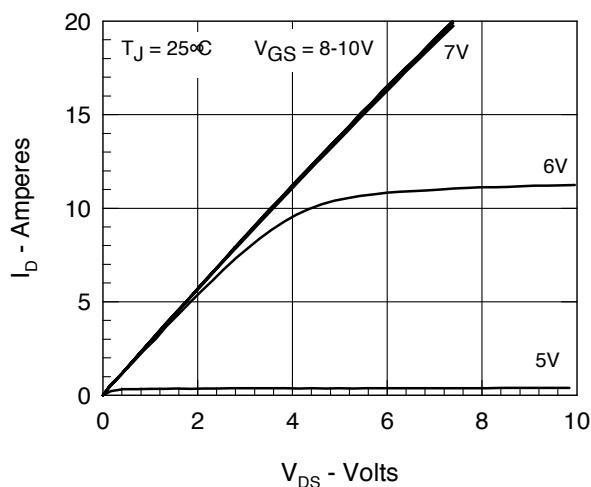


Figure 1. Output Characteristics at  $25^\circ\text{C}$

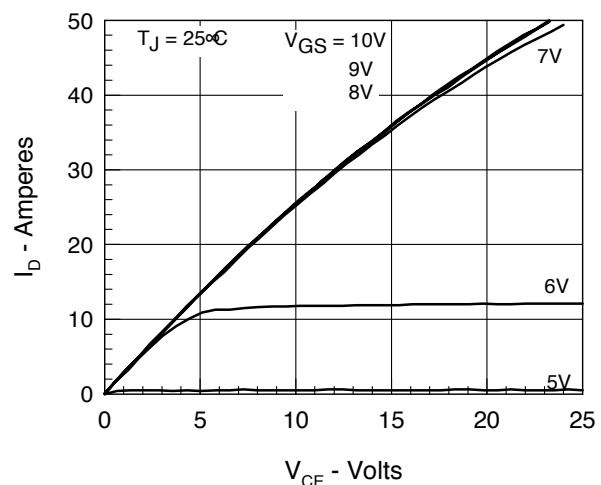


Figure 2. Extended Output Characteristics at  $125^\circ\text{C}$

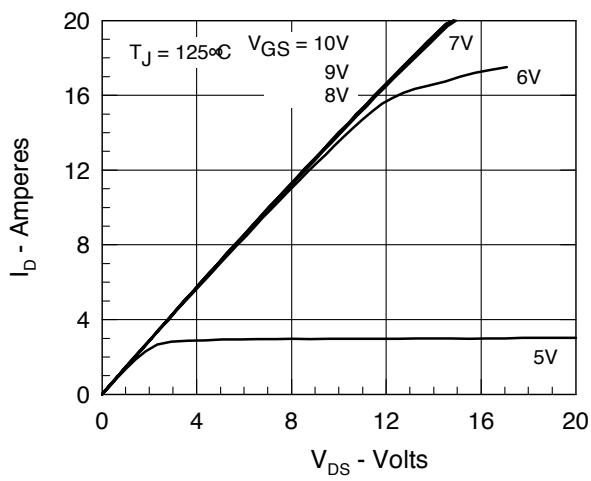


Figure 3.  $R_{DS(\text{on})}$  normalized to  $0.5 I_{D25}$  value vs.  $I_D$

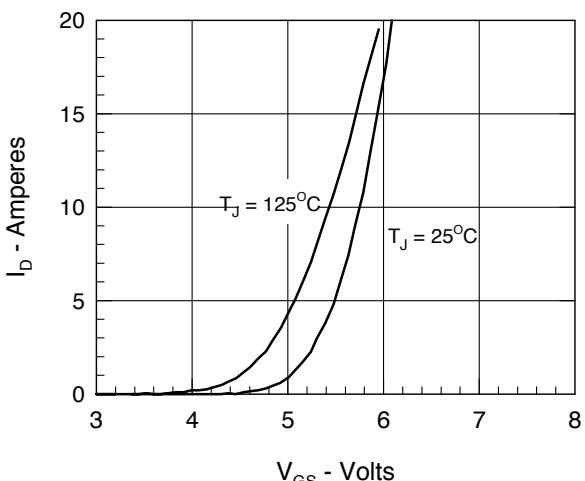


Figure 4. Admittance Curves

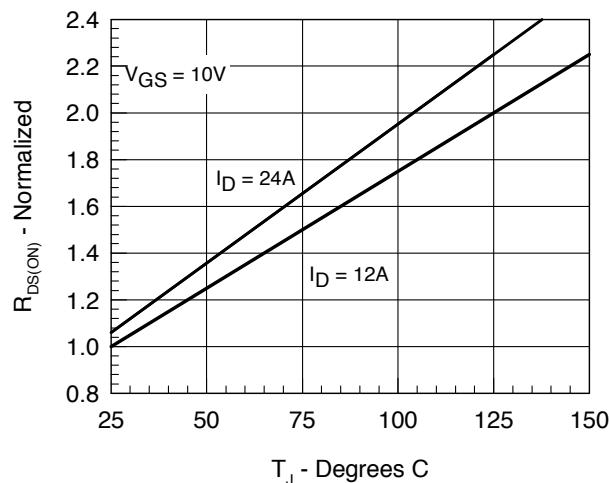


Figure 5.  $R_{DS(\text{on})}$  normalized to  $0.5 I_{D25}$  value vs.  $T_J$

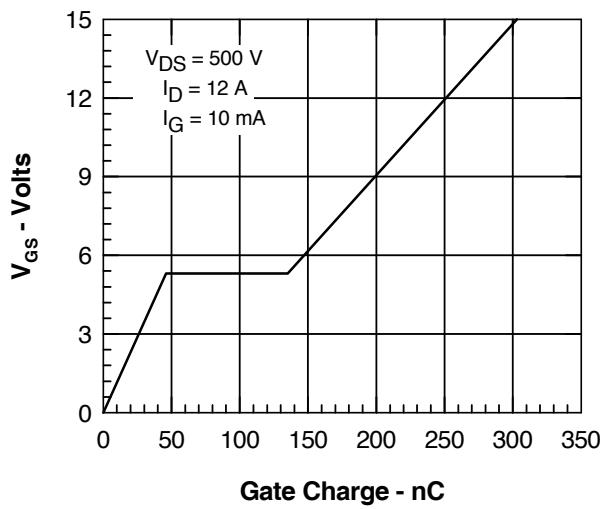


Figure 6. Gate Charge

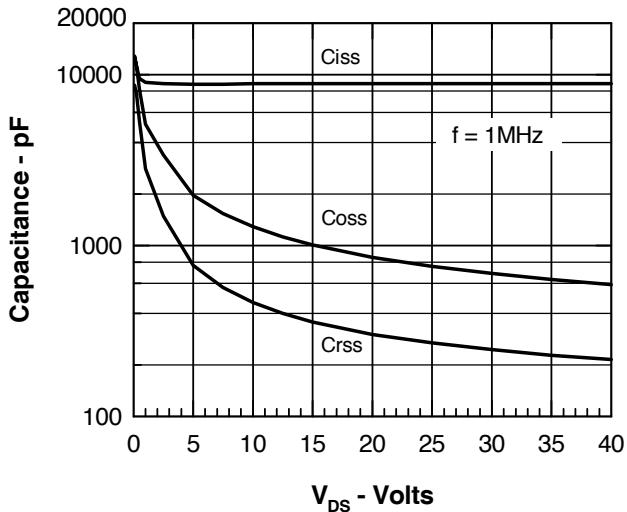


Figure 7. Capacitance Curves

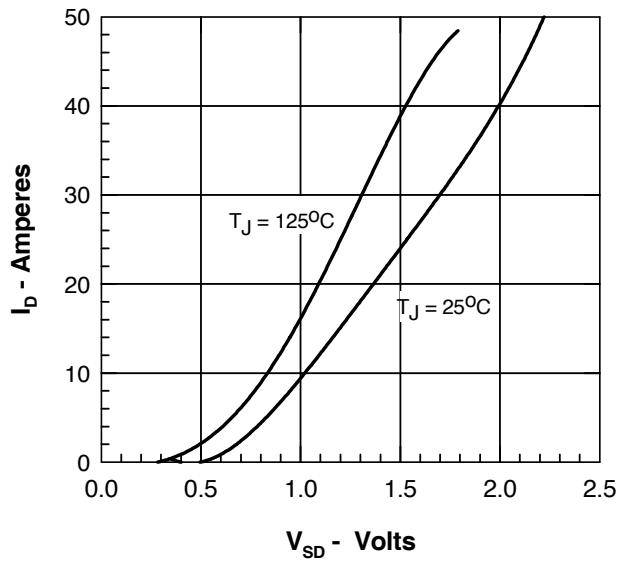


Figure 8. Forward Voltage Drop of the Intrinsic Diode

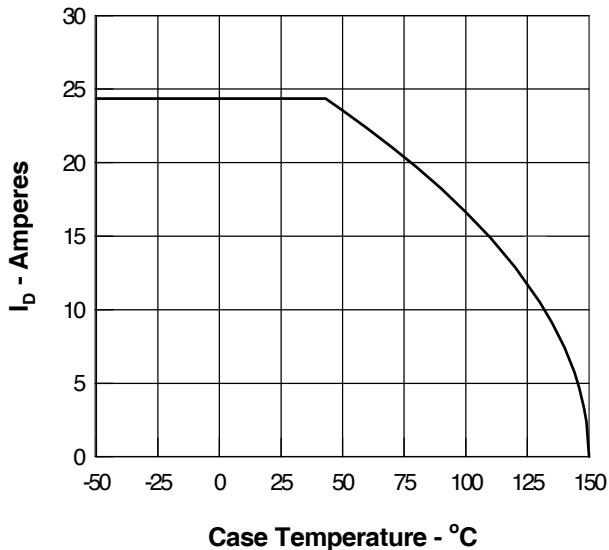


Figure 9. Drain Current vs. Case Temperature

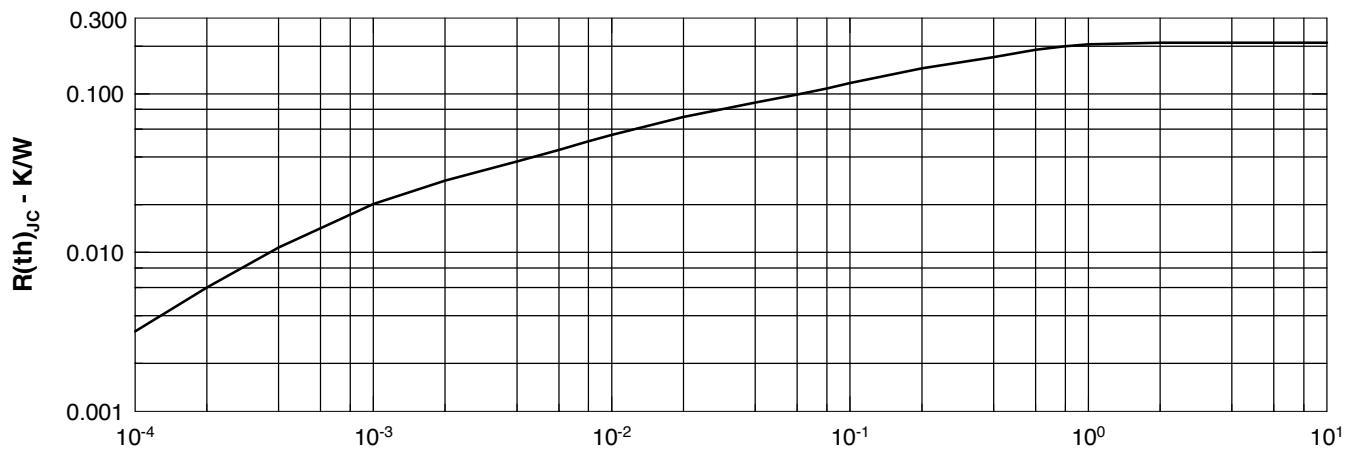


Figure 10. Transient Thermal Resistance